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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants :Akihiko ENDO et al.

Group Art Unit : 2811

Appl. No. : 10/570,665

Examiner : Shaun M CAMPBELL

Filed : March 6, 2006

Confirmation No. : 1241

For : BONDED WAFER AND ITS MANUFACTURING METHOD

RESPONSE UNDER 37 C.F.R. § 1.116

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop AF
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir :

This Amendment is responsive to the Office Action mailed September 10, 2008. Applicants respectfully request reconsideration and withdrawal of each of the rejections of the outstanding Office Action, and request allowance of all the claims pending herein. Inasmuch as the three-month shortened statutory period is set in the Office Action to expire on December 10, 2008, this response is being filed in a timely manner and no fee for extension of time is deemed necessary. Should any extension of time fees or other fees be required to maintain pendency of the application, however, including any necessary extension of time to allow for an Examiner's Amendment, authorization is hereby provided to charge any fees to Deposit Account No. 19-0089.

Remarks begin on page 2 of this paper.